

D15FY15ST

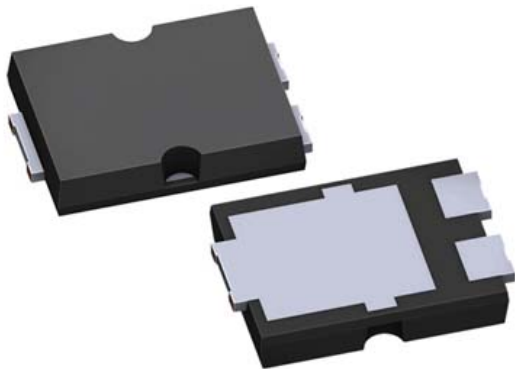
Schottky Barrier Diodes
150V, 15A

Feature

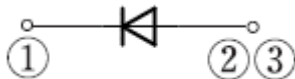
- Permit high current with a small package
- High Voltage
- Tj=175°C
- Ultra low I_R
- Based on AEC-Q101
- Halogen free
- Pb free terminal
- RoHS:Yes

OUTLINE

Package (House Name): FY
Package (JEDEC Code): TO-277A similar



Equivalent circuit



Absolute Maximum Ratings (unless otherwise specified : Tl=25°C)

Item	Symbol	Conditions	Ratings	Unit
Storage temperrature	Tstg		-55 to 175	°C
Junction temperature	Tj		-55 to 175	°C
Repetitive peak reverse voltage	V _{RRM}		150	V
Average forward current	I _{F(AV)}	50Hz sine wave, Resistance load, With heatsink ,Tl=138°C ※	15	A
Average forward current	I _{F(AV)}	50Hz sine wave, Resistance load, On alumina substrate, Ta=25°C ※	3.8	A
Average forward current	I _{F(AV)}	50Hz sine wave, Resistance load, On glass-epoxy substrate, Ta=25°C ※	3.5	A
Surge forward current	I _{FSM}	50Hz sine wave, Non-repetitive, 1 cycle, Peak value, Tj=25°C	230	A

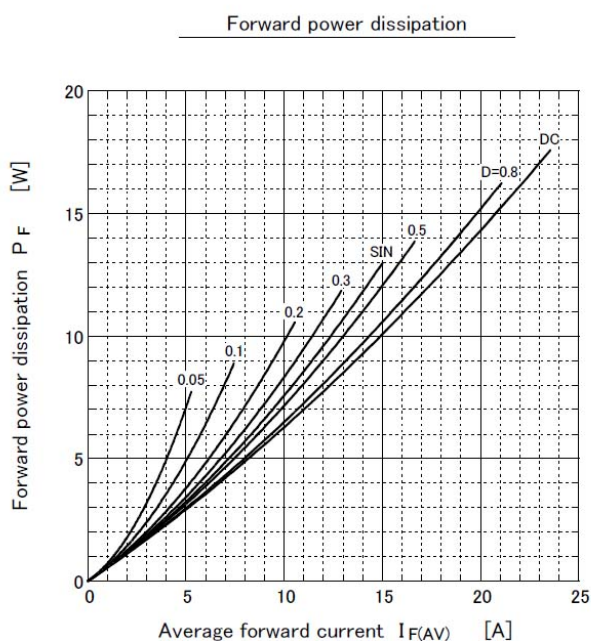
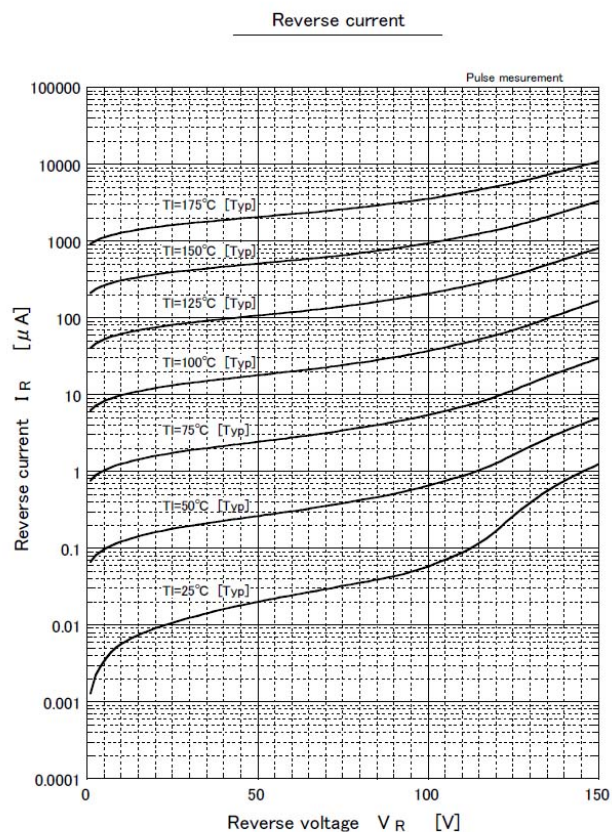
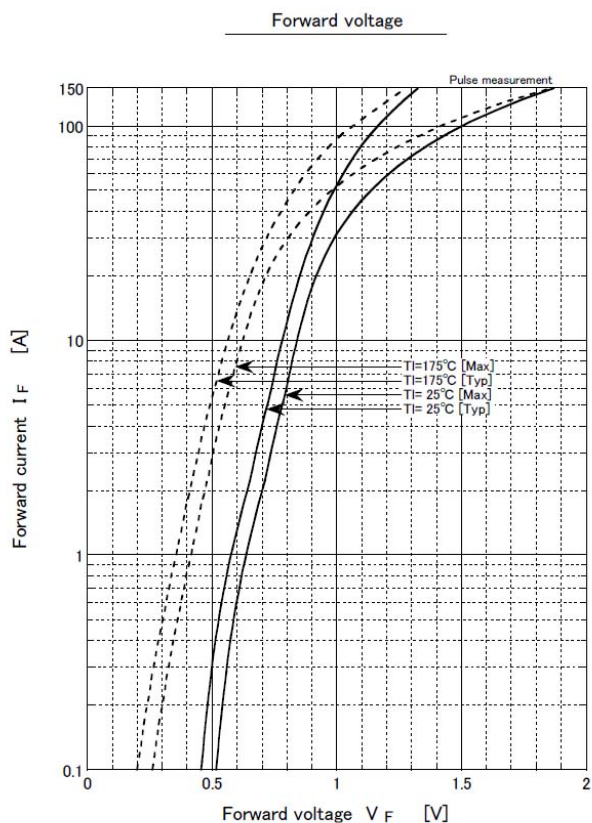
※ : See the original Specifications

Electrical Characteristics (unless otherwise specified : Tl=25°C)

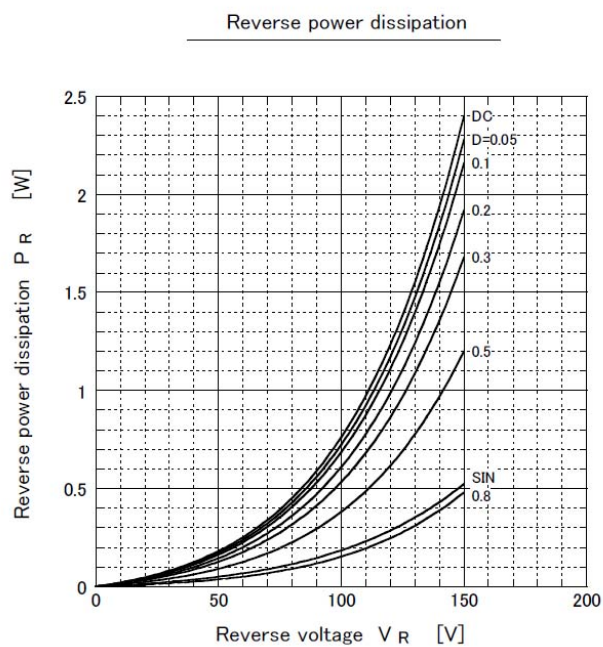
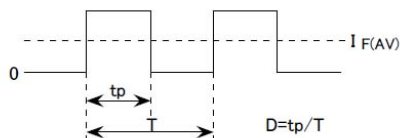
Item	Symbol	Conditions	Ratings			Unit
			MIN	TYP	MAX	
Forward voltage	V_F	IF=15A, Pulse measurement			0.88	V
Reverse current	I_R	VR=150V, Pulse measurement			0.04	mA
Total capacitance	Ct	f=1MHz, VR=10V		209		pF
Thermal resistance	Rth(j-l)	Junction to lead, With heatsink ※			2.8	°C/W
Thermal resistance	Rth(j-a)	Junction to ambient, On alumina substrate ※			60	°C/W
Thermal resistance	Rth(j-a)	Junction to ambient, On glass-epoxy substrate ※			65	°C/W

※ :See the original Specifications

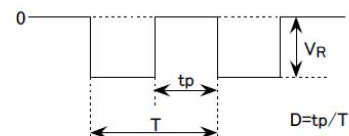
CHARACTERISTIC DIAGRAMS



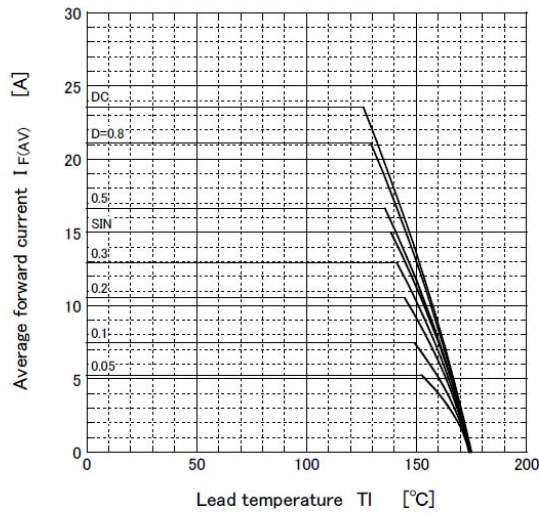
● $T_j = 175^\circ\text{C}$



● $T_j = 175^\circ\text{C}$



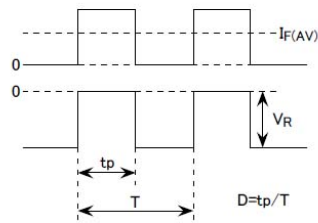
Derating curve



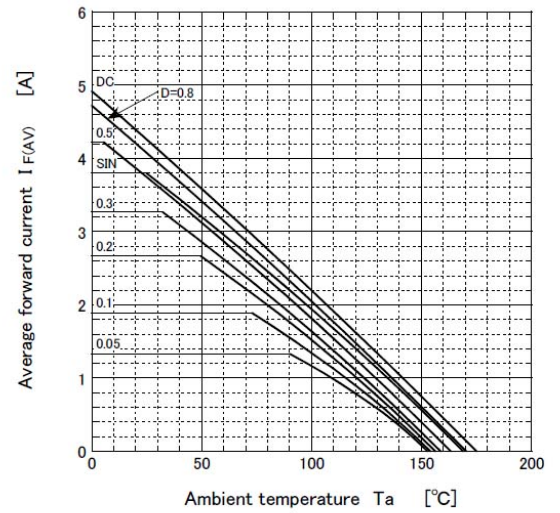
- $V_R = 75V$
R-load
With heatsink

- Substrate detail

Item	
Substrate	Alumina
Substrate thickness	1mm
Conductor thickness	20μm
Pattern area	400mm ²



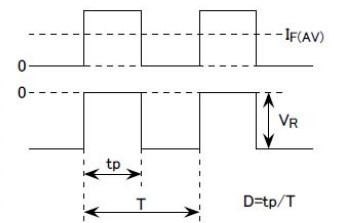
Derating curve



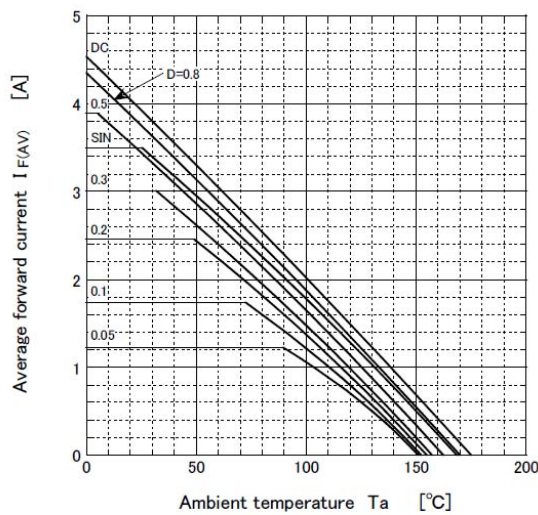
- $V_R = 75V$
R-load
Free in air

- Substrate detail

Item	
Substrate	Alumina
Substrate thickness	1mm
Conductor thickness	20μm
Pattern area	400mm ²



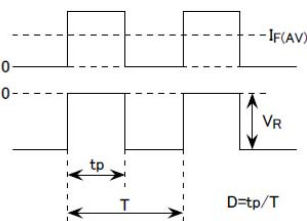
Derating curve



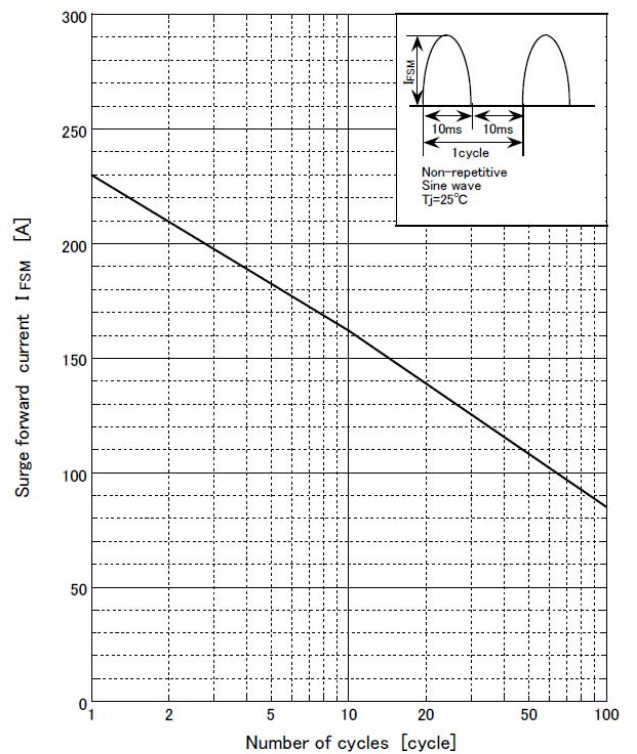
- $V_R = 75V$
R-load
Free in air

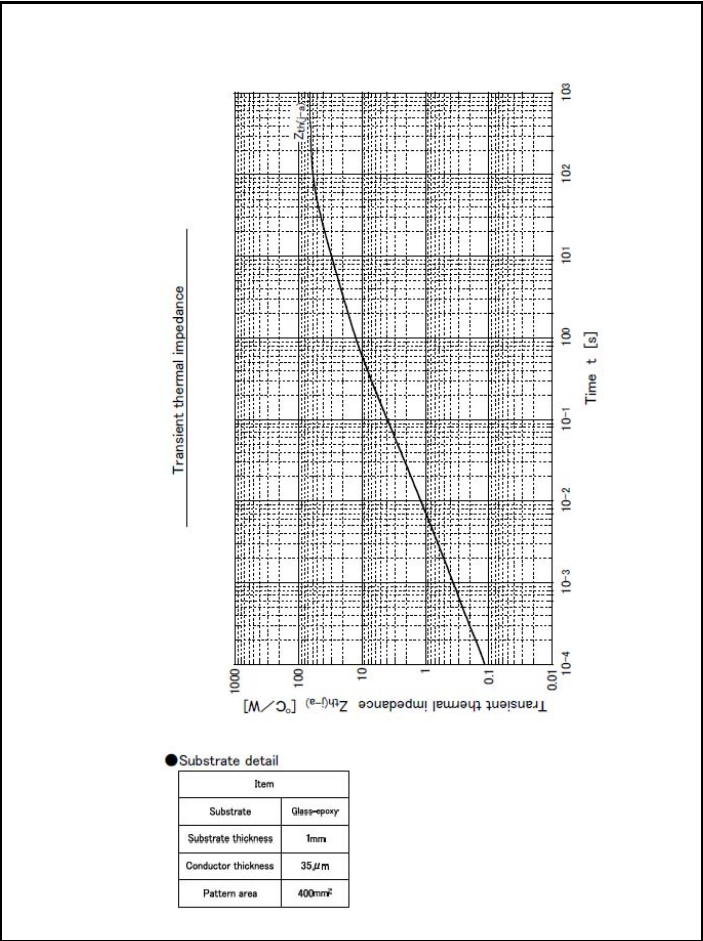
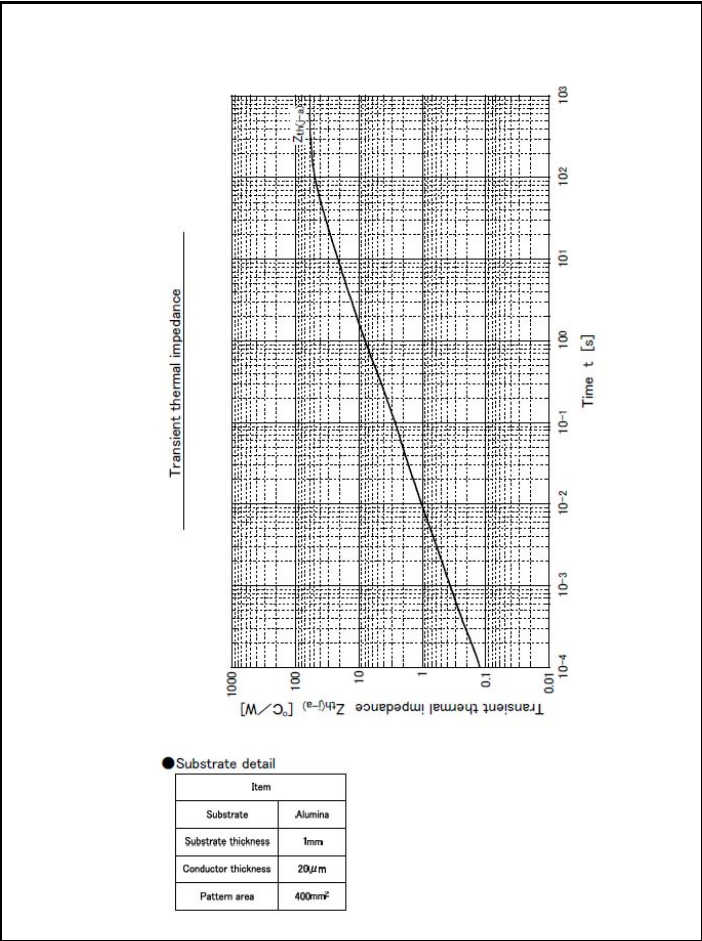
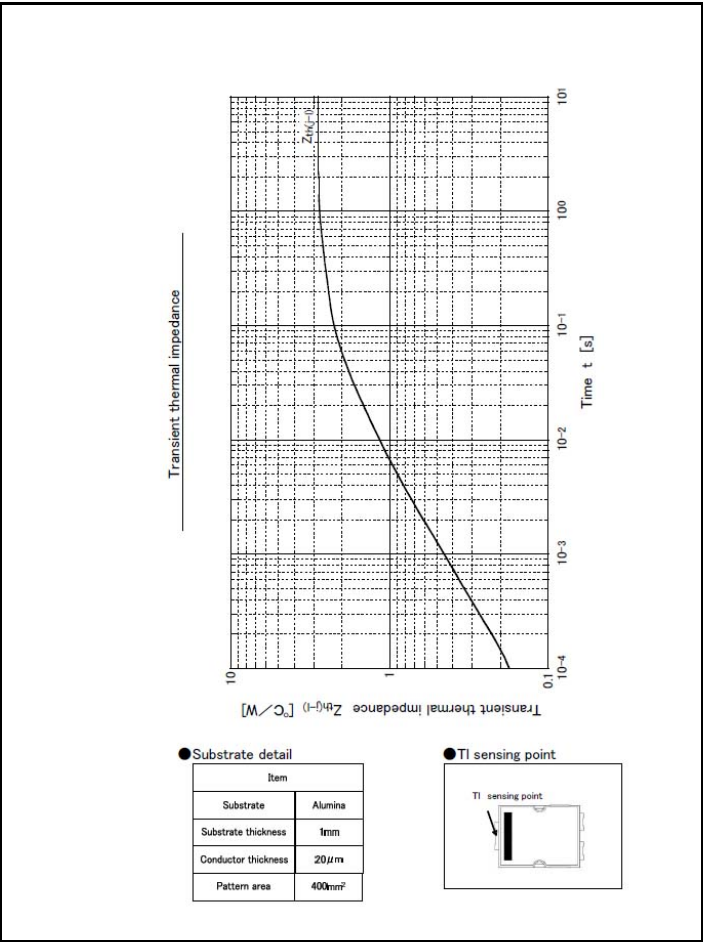
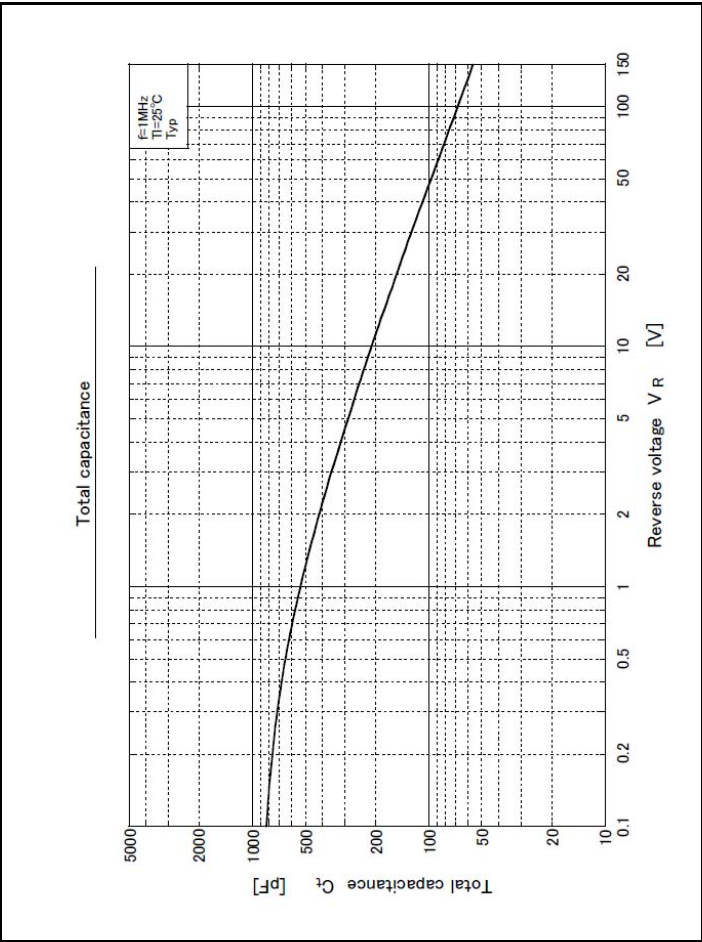
- Substrate detail

Item	
Substrate	Glass-epoxy
Substrate thickness	1mm
Conductor thickness	35μm
Pattern area	400mm ²



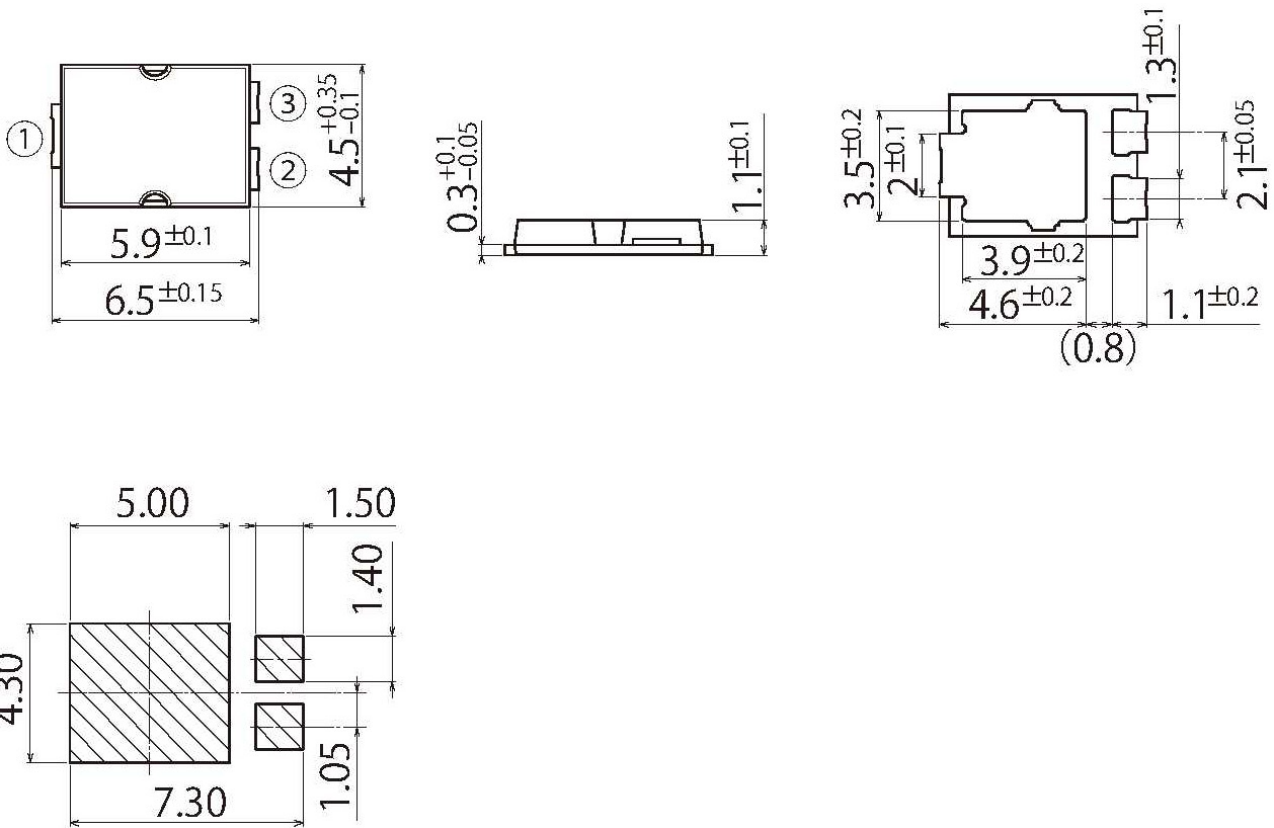
Surge forward current capability





G4

JEDEC Code	TO-277A similar
JEITA Code	—
House Name	FY



Referential Soldering Pad

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